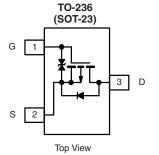




P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY							
V _{DS} (V)	$R_{DS(on)}(\Omega)$	V _{GS(th)} (V)	I _D (mA)				
- 60	6 at V _{GS} = - 10 V	- 1 to - 3.0	- 185				



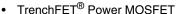
Marking Code: 6Kwll 6K = Part Number Code for TP0610K w =Week Code // = Lot Traceability

Ordering Information: TP0610K-T1 TP0610K-T1-E3 (Lead (Pb)-free)

TP0610K-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

Halogen-free According to IEC 61249-2-21 Available



High-Side Switching

Low On-Resistance: 6 Ω

Low Threshold: - 2 V (typ.)

Fast Swtiching Speed: 20 ns (typ.)

Low Input Capacitance: 20 pF (typ.)

2000 V ESD Protection

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- **Battery Operated Systems**
- **Power Supply Converter Circuits**
- Solid-State Relays

BENEFITS

- Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- **High-Speed Circuits**
- Easily Driven without Buffer

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C	, unless otherwise	noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	- 60	V	
Gate-Source Voltage		V _{GS}	± 20		
Outline Date Outline	T _A = 25 °C	I _D	- 185	mA	
Continuous Drain Current ^a	T _A = 100 °C		- 115		
Pulsed Drain Current ^b		I _{DM}	- 800		
David Distriction	T _A = 25 °C	P _D	350	mW	
Power Dissipation ^a	T _A = 100 °C		140		
Maximum Junction-to-Ambient ^a		R _{thJA}	350	°C/W	
Operating Junction and Storage Temperature Range		T _{J,} T _{stg}	- 55 to 150	°C	

- a. Surface Mounted on FR4 board.
- b. Pulse width limited by maximum junction temperature.

RoHS³ COMPLIANT

HALOGEN **FREE**

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

TP0610K

Vishay Siliconix



SPECIFICATIONS T _A = 25 °C, unless otherwise noted								
Parameter	Symbol		Limits					
		Test Conditions	Min.	Typ. ^a	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = -10 \mu\text{A}$	- 60			3.0 V		
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3.0			
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 10	μΑ		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$			± 200	mA		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			± 500			
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$			± 100			
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V			- 25			
		V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 85 °C			- 250			
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V, V _{DS} = - 4.5 V	- 50			mA		
		V _{GS} = - 10 V, V _{DS} = - 10 V	- 600					
Drain-Source On-Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 25 mA			10	Ω		
		V _{GS} = - 10 V, I _D = - 500 mA			6			
		V _{GS} = - 10 V, I _D = - 500 mA, T _J =125 °C			9			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 100 mA	80			mS		
Diode Forward Voltage	V _{SD}	I _S = - 200 mA, V _{GS} = 0 V			- 1.4	٧		
Dynamic	•	,			I.			
Total Gate Charge	Qg	V 20 V V 15 V		1.7		nC		
Gate-Source Charge	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -15 \text{ V}$ $I_{D} \cong -500 \text{ mA}$		0.26				
Gate-Drain Charge	Q _{gd}	10 = 3000 mA		0.46				
Input Capacitance	C _{iss}	V _{DS} = - 25 V, V _{GS} = 0 V f = 1 MHz		23		pF		
Output Capacitance	C _{oss}			10				
Reverse Transfer Capacitance	C _{rss}	1 — 1 IVII 12		5				
Switching ^b				•		•		
Turn-On Time	t _{d(on)}	$V_{DD} = -25 \text{ V}, R_{L} = 150 \Omega$		25		ns		
Turn-Off Time	t _{d(off)}	$I_D \cong$ - 200 mA, V_{GEN} = - 10 V, R_G = 10 Ω		35				

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test: PW $\leq 300~\mu s$ duty cycle $\leq 2~\%.$

b. Switching time is essentially independent of operating temperature.